LTCC SURFACE MOUNT ow Pass Filter

LFCV-2502+

50Ω DC to 25 GHz

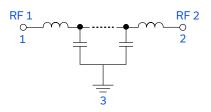
THE BIG DEAL

- Stopband Rejection, up to 39 dB Typ.
- Low Insertion Loss, 2.2 dB Typ.
- Passband Return Loss, 13 dB Typ.
- Rugged Ceramic Construction
- Small Size, 1210 Surface Mount Footprint



Generic photo used for illustration purposes only

FUNCTIONAL DIAGRAM



APPLICATIONS

- Communications
- Radar, EW, and ECM Defense Systems
- Test & Measurement Equipment

PRODUCT OVERVIEW

Mini-Circuits' LFCV-2502+ is a miniature low-temperature co-fired ceramic (LTCC) low pass filter with a DC to 25 GHz passband that supports a variety of applications. This model provides 2.2 dB typical insertion loss over a wide band, due to its rugged monolithic construction. Housed in a small 1210 ceramic form factor, the filter is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well-suited for environmental extremes of high humidity and temperature.

KEY FEATURES

| Feature | Advantages | |
|--------------------------------|--|--|
| Ultra-wide Stopband | Provides excellent stopband rejection to 50 GHz and beyond, suitable for wide band applications. | |
| LTCC Construction | The use of LTCC technology allows for repeatable performance in a rugged ceramic package, well suited for tough environments such as high humidity and temperature extremes. See Mini-Circuits Environmental Rating ENV06T10 for more information. | |
| Excellent Performance for Size | Offers best in class performance relative to larger-size alternative technologies. This mmWave multi-layer surface mount LTCC filter in a 1210 package allows for space to be saved in dense circuit board layouts, while also minimizing the effects of parasitics. | |

LFCV-2502+

DC to 25 GHz 50Ω

ELECTRICAL SPECIFICATIONS1,2,3 AT 25°C

| ı | Parameter | F# | Frequency (GHz) | Min. | Тур. | Max. | Units |
|-----------|----------------|-------|-----------------|------|------|------|-------|
| | Insertion Loss | DC-F1 | DC - 25 | _ | 2.2 | 3.4 | |
| Passband | Freq. Cut-Off⁴ | Fc | 25.8 | _ | 3 | _ | dB |
| | Return Loss | DC-F1 | DC - 25 | _ | 13 | _ | |
| Stop Band | | F2-F3 | 34 - 40 | 29 | 39 | _ | |
| | Rejection | F3-F4 | 40 - 50 | 22 | 32 | _ | dB |
| | | F4-F5 | 50 - 67 | _ | 24 | _ | |

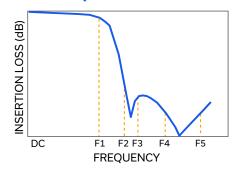
^{1.} Tested on Evaluation Board P/N TB-LFCV-2502C+, with the connector and feedline effects de-embedded using the 2XThru IEEE P370 method.

ABSOLUTE MAXIMUM RATINGS⁵

| Parameter | Ratings |
|-----------------------------|-----------------|
| Operating Temperature | -55°C to +125°C |
| Storage Temperature | -55°C to +125°C |
| RF Power Input ⁶ | 1 W |

^{5.} Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE AT 25°C



^{2.} Bi-directional RF1 and RF2 ports can be interchanged.
3. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

^{4.} Typical variation ±3%.

Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.5 W at +125°C.



LTCC SURFACE MOUNT

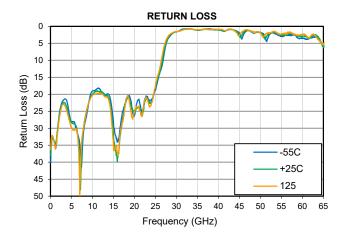
ow Pass Filter

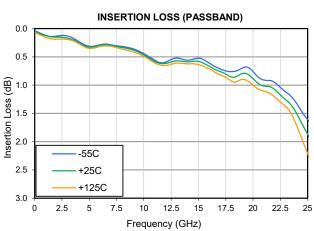
50Ω DC to 25 GHz

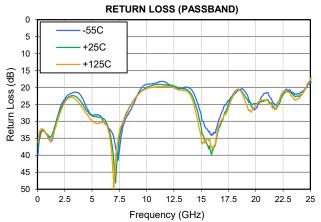
LFCV-2502+

TYPICAL PERFORMANCE GRAPHS











LTCC SURFACE MOUNT

ow Pass Filter

DC to 25 GHz 50Ω

LFCV-2502+

FUNCTIONAL DIAGRAM

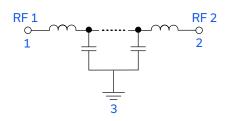
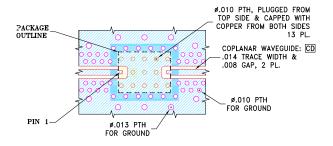


Figure 1. LFCV-2502+ Functional Diagram

PAD DESCRIPTION

| Function | Pad Number | Description |
|------------------|------------|--|
| RF1 ² | 1 | Connects to RF Input Port |
| RF2 ² | 2 | Connects to RF Output Port |
| GROUND | 3 | Connects to Ground on PCB, (See drawing PL-743) |

SUGGESTED PCB LAYOUT (PL-743)



STACK-UP DIAGRAM



- 1. TOTAL FINISHED THICKNESS 0.026 ± 10%.

 2. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.

 3. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.

 4. L2, L3 AND L4 ARE CONTINUOUS GROUND PLANES.

- 1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
- TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON-7 R-5785(N/GN), WITH DIELECTRIC THICKNESS .0079; COPPER: 1/2 OZ. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.

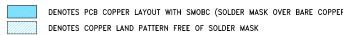
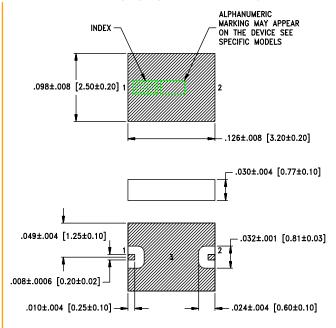


Figure 2. Suggested PCB Layout PL-743

CASE STYLE DRAWING



METALLIZATION

Weight: .024 grams

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.010; 3 Pl. ±.005

PRODUCT MARKING*: WM

*Marking may contain other features or characters for internal lot control.



LFCV-2502+

ADDITIONAL INFORMATION IS AVAILABLE ON OUR DASHBOARD

CLICK HERE

| | Data |
|---------------------------------|---|
| Performance Data & Graphs | Graphs |
| | S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads |
| Case Style | JV1210C-13 Lead Finish: Gold over Nickel Plating |
| RoHS Status | Compliant |
| Tape and Reel | F74 |
| Suggested Layout for PCB Design | PL-743 |
| Evaluation Board | TB-LFCV-2502C+ |
| Evaluation board | Gerber File |
| Environmental Ratings | ENV06T10 |

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

